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TRADEMARK ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 ETAS ID: TM368011

SUBMISSION TYPE:	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:	RELEASE OF SECURITY INTEREST		

CONVEYING PARTY DATA

Name	Formerly	Execution Date	Entity Type
MADISON CAPITAL FUNDING LLC		01/01/2016	LIMITED LIABILITY COMPANY: DELAWARE

RECEIVING PARTY DATA

Name:	B+B SMARTWORX INC.
Street Address:	707 DAYTON ROAD
City:	OTTAWA
State/Country:	ILLINOIS
Postal Code:	61350
Entity Type:	CORPORATION: DELAWARE

PROPERTY NUMBERS Total: 4

Property Type	Number	Word Mark
Registration Number:	2301673	AUTO TAP
Registration Number:	3201028	ELINX
Serial Number:	78735905	ZLINX
Serial Number:	77231244	ELINX

CORRESPONDENCE DATA

Fax Number: 6508134848

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 6508134800

Email: patents@dechert.com

Correspondent Name: Dechert LLP

Address Line 1: 2440 W. El Camino Real

Address Line 2: Suite 700

Address Line 4: Mountain View, CALIFORNIA 94040

ATTORNEY DOCKET NUMBER:	380582-141546
NAME OF SUBMITTER:	Ryan R. Tooley
SIGNATURE:	/Ryan R. Tooley/
DATE SIGNED:	01/05/2016
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Total Attachments: 3

TRADEMARK REEL: 005702 FRAME: 0629 source=Trademark_Release_1#page1.tif
source=Trademark_Release_1#page2.tif
source=Trademark_Release_1#page3.tif

TRADEMARK REEL: 005702 FRAME: 0630

RELEASE OF SECURITY INTEREST IN TRADEMARKS

THIS RELEASE OF SECURITY INTEREST IN TRADEMARKS ("Release") is

made as of this 1st day of January 2016, by MADISON CAPITAL FUNDING LLC, in its

capacity as agent ("Agent"), in favor of B+B SMARTWORX INC. (formerly known as B&B

Electronics Manufacturing Company), a Delaware corporation ("Company").

Reference is made to that certain Payoff Letter dated as of January 1, 2016 by and

among Agent, the Company and certain affiliates of the Company party thereto (the "Payoff

Letter").

FOR GOOD AND VALUABLE CONSIDERATION, the receipt and adequacy of

which are hereby acknowledged, subject to the terms and conditions of the Payoff Letter, Agent

hereby releases its liens on and security interests in the trademarks listed on Schedule A attached

hereto and made a part hereof, which liens and security interests were established under and

pursuant to that certain Trademark Security Agreement dated April 4, 2008 executed by

Company in favor of Agent and recorded with the United States Patent and Trademark Office on

April 4, 2008 at Reel/Frame 3753/0333 and on September 2, 2011 at Reel/Frame 4615/0748.

[Signature Page Follows]

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TRADEMARK REEL: 005702 FRAME: 0631 IN WITNESS HEREOF, Agent has caused this Release to be duly executed by its duly authorized officer as of the day and year first above written.

MADISON CAPITAL FUNDING LLC, as Agent

Name: _

Title: Vice President

Trademark Release B+B (2)

SCHEDULE A

TRADEMARK REGISTRATIONS

Trademark	Application	Application	Registration	Registration	Jurisdiction
	Number	Date	Number	Date	of
					Registration
AUTO TAP	75/493,672	5/21/1998	2,301,673	12/21/1999	U.S.
(stylized)					
ELINX	78/735,899	10/19/2005	3,201,028	1/23/2007	U.S.
(stylized)					
AUTO TAP	42201266		082228	6/24/98	Illinois
(words					
only)					

TRADEMARK APPLICATIONS

Trademark	Application	Application	Jurisdiction
	Number	Date	of
			Registration
ZLINX	78/735,905	10/19/2005	U.S.
ELINX	77/231,244	7/17/2007	U.S.
B&B ELECTRONICS	6,210,151	8/8/2007	China
MANUFACTURING COMPANY			
ELINX	6,207,059	8/6/2007	China
VLINX	6,207,057	8/6/2007	China
ZLINX	6,207,058	8/6/2007	China

RECORDED: 01/05/2016

TRADEMARK REEL: 005702 FRAME: 0633